

1752-2 1.1

Material Composition Declaration

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility. Declaration Class*

ICP Web Site for information on IPC-1752 Standard http://www.ipc.org/IPC-175x

Form Type* Distribute Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Infomation

	Infoliation					
Supplier Information						
Company Name *	Company Unique ID	Unique ID Authority	Response Date*			
Fairchild Semiconductor	00-489-5751	Dun & Bradstreet	Sat, Aug 24, 2013 04:00 AM			
Contact Name *	Title - Contact	Phone - Contact *	Email - Contact *			
David Lancaster	Product Ecology	801-562-7455	david.lancaster@fairchildsemi.com			
Authorized Representative *	Title - Representative	Phone - Representative *	Email - Representative *			
David Lancaster	Product Ecology	801-562-7455	david.lancaster@fairchildsemi.com			

Requester Item Number	Mfr Ite	m Number	Mfr Item Name		Effective Date	Version	1	Manufacturing Site	Weight*	UOM	Unit Type
QRE1113 QRE111		E1113	Non-Focus Sens SMT-4	nsor			INTE	ERNAL PENANG	0.047862	g	Each
Manufacturing Process Information											
Terminal Finish	Base Alloy	J-STD-020 MSL Rating			Peak Process Body Temperature		Max Time at Peak Temperature		No Reflow cycles		
Matte Tin (Sn)		Not Applicable		С		seconds		Not A	Not Applicable		

* Required Field

RoHS Material	Composition Declaration	Declaration Type * Custom					
RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium						
restriction of the	Fairchild Semiconductor's statement regarding the directive 2011/65/EU of the European Parliament and of the cou ise of certain hazardous substances in electrical and electronic equipment (RoHS Recast). The content of this docun irchild Semiconductor supply chain, manufacturing facilities and affiliates worldwide.						
ensure our production independently vertices	The FSC part number listed above and the homogenous materials in the product are compliant with the Directive 2011/65/EU. Fairchild has implemented systems to ensure our products are compliant to environmental regulations and laws worldwide. However, not all materials in Fairchild's products may have been independently verified regarding substance content. In the event of any issues arising from information in this document, the warranty section of Fairchild's standard terms and conditions of sale shall apply, unless alternate contracts have been agreed upon in writing by both parties.						
Safety Data Sheet miniscule quantit	the content disclosed herewith is approximate and is based on various methods including, engineering calculations, is, analytical measurements. Fairchild may update this document without notification. This statement may not include of dopant and metal materials in the electrical devices contained within the finished product. CAS numbers listed contain alternate substances of similar composition.	le information regarding the					
RoHS Declaration	* 1 - Item(s) does not contain RoHS restricted substances per the definition above Sup	plier Acceptance * Accepted					
1 · · · · · · · · · · · · · · · · · · ·	ne declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exer ponse in the RoHS Declaration above and choose all applicable exemptions.	nptions, then select the					
Exemption None	List Version EL-2011/534/EU						
Declaration Sign	ature						

David Loncosto

Supplier Signature

DAVID LANCASTER - PRODUCT ECOLOGY MANAGER

Homogeneous Material Composition Declaration for Electronic Products

Item/SubItem Name Non-Focus Sensor SMT-4

Component	Material	Weight (mg)	Jig Level	Substance Category	Substance	Weight (mg)	CAS	РРМ
Chip	Other inorganic materials	0.301	Supplier		Gallium Arsenide	0.045	1303-00-0	944
			Supplier		Silicon	0.256	7440-21-3	5349
Die Attach	Other Organic Materials	0.052	Supplier		Acrylic Resin	0.013	54208-63-8	272
			Supplier		Silver	0.039	7440-22-4	815
Encapsulation	Thermoplastics	0.003	Supplier		Epoxy Resin	0.003	29690-82-2	61
Housing	Other Organic Materials	5.236	Supplier		Carbon Black	0.052	1333-86-4	1094
			Supplier		Fiberous glass	1.884	65997-17-3	39372
			Supplier		Polyphthalamide	2.388	96385-50-1	49885
			Supplier		Titanium Dioxide	0.912	13463-67-7	19046
Lead Frame	Copper & its alloys	42.260	Supplier		Copper	28.800	7440-50-8	601728
			Supplier		Silver	1.060	7440-22-4	22147
			Supplier		Zinc	12.400	7440-66-6	259077
Wire Bond	Precious metals	0.010	Supplier		Gold	0.010	7440-57-5	209